KYCON



UNIVERSAL SERIAL BUS: KUSBVLPX Series VERTICAL, A TYPE, LOW PROFILE USB

Product Features

Vertical Low Profile 10mm Height Through hole

Performance Specifications

Materials and Finish

Insulator

UL94V-0 Rated, Thermoplastic, Color White or Black

Contact Material Copper Alloy

Plating Options

Standard: Gold flash on contact area, Tin on Soldertails

all over 40µ" nickel min.

30 Option: 30µ" Gold on contact area, Tin on Soldertails

all over 40µ" nickel min.

Shield

Nickel Plating

Electrical Characteristics

Rated Voltage: 30V AC

Contact Current Rating: 3A Max.
Contact Resistance: 30 milliohms Max
Insulation Resistance: 1000 Megohms Min.
Dielectric Withstanding: 250V AC for 1 minute

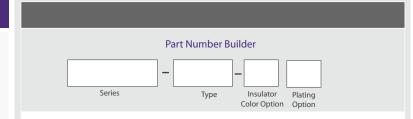
Mechanical Characteristics

Insertion Force: 3.57kg max. Extraction Force: 1.02kg min. Durability: 1500 Mating Cycles

OperatingTemperature: -55°C to +85°C

2D Drawing	IGES	STEP	3D PDF
Solder Profile	CofC RoHS Compliant	CofC REACH Compliant	UL Plastic File
Certificate of Origin	Check Stock	Request a Sample	Send Us An Email

Generated Part Number



Series

KUSBVLPX - Vertical Low Profile

Type

AS1N - Single A Type

Insulator Color Option

B - Black W - White

Plating Option

Blank - Gold Flash 30 - 30µ" Gold Plating

Contact Kycon for other options

KUSBVLPX

Dimensions in mm

